Application Serial No. 09/904,425 Amendment dated February 2, 2009 in Response to non-final Office Action of July 3, 2002

## AMENDMENTS TO THE CLAIMS

The following listing of claims will replace all prior versions and listings of claims in the application:

Claim 1 (currently amended): A linearity measuring apparatus for a wafer orientation flat, comprising:

a base in which one, two, or more a plurality of straight tracks are formed in a first direction;

a platform which is configured so as to be movable in said first direction by being engaged with said <u>plurality of straight [[track]] tracks</u> via engagement means, and is further provided with a top surface formed so as to be flat to mount a wafer having an orientation flat;

a block which is installed on said base with a predetermined first clearance L being provided with the between said block and a nearest one of said plurality of straight [[track]] tracks in a second direction perpendicular to said first direction, and has a flat face against which the orientation flat of said wafer mounted on said platform abuts and which is parallel with said first direction;

wafer fixing means provided in said platform to fix said wafer in a state in which said wafer is mounted on said platform; and

a measurement device which is installed on said base with a predetermined second clearance M being provided with said block in said first direction, and has a probe that is opposed to said plurality of straight tracks [[track]] and is capable of being displaced in said second direction, wherein

when a clearance between [[the]] a tip end of said probe and the nearest one of said

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plurality of straight tracks [[track]] is taken as N, the following equation (1) is satisfied:

$$0 \mu m < L-N \le 100 \mu m_{\underline{.}}$$
 [[······· (1)]]

Claim 2 (currently amended): The linearity measuring apparatus according to claim 1, wherein said wafer fixing means has a suction port formed in said platform to attract and fix said wafer, a suction passage communicating with said suction port, and a switching valve provided in said suction passage to switch said suction port to a negative pressure or [[the]] atmospheric pressure.

Claim 3 (currently amended): The linearity measuring apparatus according to claim 1, wherein release means for moving said block in said second direction in which said block goes apart from said <u>plurality of straight tracks</u> [[track]] is installed on said base.

Claim 4 (original): The linearity measuring apparatus according to claim 1, wherein deflection data displayed on said measurement device can be outputted as an electronic signal.

Claim 5 (original): The linearity measuring apparatus according to claim 1, wherein said apparatus can be applied to a wafer having a diameter in the range of 50 to 300 mm.